

40V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	$R_{DS(ON)}$ max $T_A = +25$ °C	
	20mΩ @ V _{GS} = 10V	8.0A
40V	28mΩ @ V _{GS} = 4.5V	6.7A

Description and Applications

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- General Purpose Interfacing Switch
- Power Management Functions

Features and Benefits

- 0.6mm Profile Ideal for Low Profile Applications
- PCB Footprint of 4mm²
- Low Gate Threshold Voltage
- Low On-Resistance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

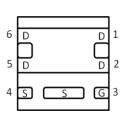
Mechanical Data

- Case: U-DFN2020-6 (Type E)
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208[®]
- Weight: 0.0065 grams (Approximate)

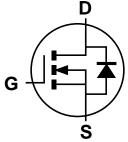
U-DFN2020-6 (Type E)



Bottom View



Pin Out



Equivalent Circuit

Ordering Information (Note 4)

Part Number	Marking	Reel Size (inches)	Quantity Per Reel
DMN4020LFDE-7	NE	7	3,000
DMN4020LFDE-13	NE	13	10,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



NE = Product Type Marking Code YM = Date Code Marking Y = Year (ex: E = 2017) M = Month (ex: 9 = September)

Date Code Key

Date Code No	- y											
Year	201	1	2012		2013	20	14	2015		2016	2	2017
Code	Y		Z		Α		3	С		D		Е
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	40	V		
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Desis Courant (Nata CVV 40V	I _D	8.0 6.3	А		
Continuous Drain Current (Note 6) V _{GS} = 10V	t < 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	9.5 7.5	А
Continuous Drain Current (Note 6) V 4 5V	$T_A = +25$ °C $T_A = +70$ °C	I _D	6.7 5.3	А	
Continuous Drain Current (Note 6) V _{GS} = 4.5V	t < 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	8.0 6.4	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I _{DM}	32	Α		
Maximum Body Diode Continuous Current	Is	2.5	Α		

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Total Power Dissipation (Note 5)	T _A = +25°C	0	0.66	W	
Total Power Dissipation (Note 5)	$T_A = +70^{\circ}C$	P _D	0.42		
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	6	189	°C/W	
Thermal Resistance, Junction to Ambient (Note 3)	t < 10s	$R_{\theta JA}$	132	C/VV	
Total Dower Discipation (Note 6)	$T_A = +25^{\circ}C$	0	2.03	W	
Total Power Dissipation (Note 6)	$T_A = +70^{\circ}C$	P_{D}	1.31		
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	6	61	°C/W	
mermai Resistance, Junction to Ambient (Note 6)	t < 10s	$R_{\theta JA}$	43		
Thermal Resistance, Junction to Case (Note 6)	$R_{ heta JC}$	9.3			
Operating and Storage Temperature Range		$T_{J_i} T_{STG}$	-55 to +150	°C	

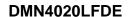
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	40	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	1	μΑ	$V_{DS} = 40V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)	<u>.</u>					
Gate Threshold Voltage	V _{GS(TH)}	1.4	_	2.4	٧	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance			15	20	mΩ	$V_{GS} = 10V, I_D = 8A$
Static Diani-Source Off-Resistance	R _{DS(ON)}	_	20	28	11122	$V_{GS} = 4.5V, I_D = 4A$
Diode Forward Voltage	V _{SD}	_	0.7	1	V	$V_{GS} = 0V, I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	_	1060	_	pF	.,
Output Capacitance	Coss	_	84	_	pF	$V_{DS} = 20V, V_{GS} = 0V,$ -f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	58	_	pF	71 = 1.0MH2
Gate Resistance	Rg	_	1.6	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	8.8	_	nC	
Total Gate Charge (V _{GS} = 10V)	Qq	_	19.1	_	nC	7,, 00,4, 04
Gate-Source Charge	Q _{gs}	_	3.0	_	nC	$V_{DS} = 20V, I_{D} = 8A$
Gate-Drain Charge	Q_{gd}	_	2.5	_	nC	
Turn-On Delay Time	t _{D(ON)}	_	5.3	_	ns	
Turn-On Rise Time	t _R	_	7.1	_	ns	$V_{DS} = 20V, R_L = 2.5\Omega$
Turn-Off Delay Time	t _{D(OFF)}	_	15.1	_	ns	$V_{GS} = 10V, R_G = 3\Omega$
Turn-Off Fall Time	t _F	_	4.8	_	ns	1
Reverse Recovery Time	t _{RR}	_	10.5	_	ns	
Reverse Recovery Charge	Q _{RR}	_	4.15	_	nC	I _F = 8A, di/dt = 100A/μs

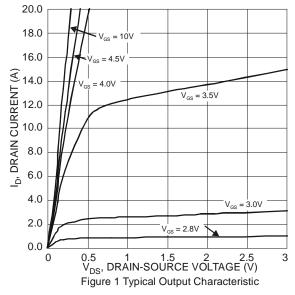
 ${\it 5. \ Device mounted on FR-4 \ PC \ board, with \ minimum \ recommended \ pad \ layout, \ single \ sided.}$ Notes:

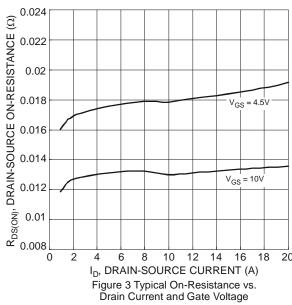
^{6.} Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
7. Short duration pulse test used to minimize self-heating effect.

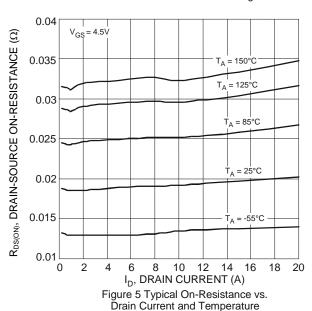
^{8.} Guaranteed by design. Not subject to production testing.

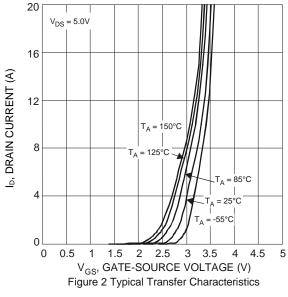


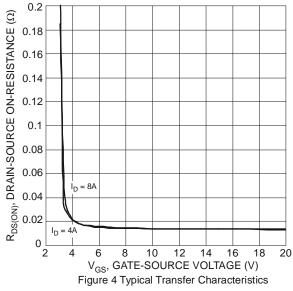












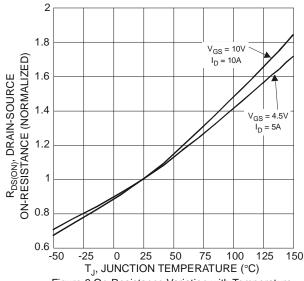
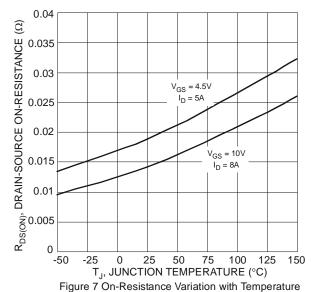
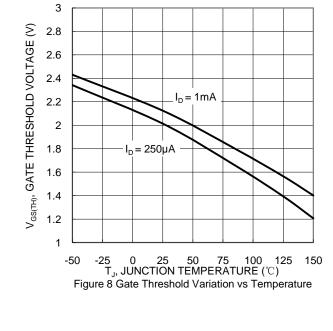


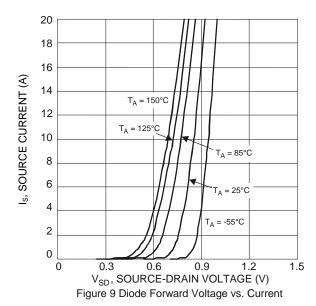
Figure 6 On-Resistance Variation with Temperature

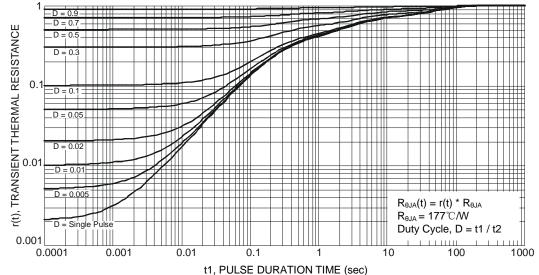










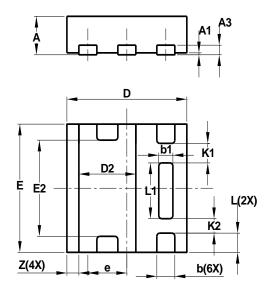




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type E)

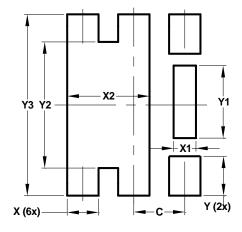


U-DFN2020-6 Type E						
Dim						
Α	0.57	0.63	0.60			
A1	0	0.05	0.03			
A3	_	_	0.15			
b	0.25	0.35	0.30			
b1	0.185	0.285	0.235			
D	1.95	2.05	2.00			
D2	0.85	1.05	0.95			
Е	1.95	2.05	2.00			
E2	1.40	1.60	1.50			
е	_	_	0.65			
L	0.25	0.35	0.30			
L1	0.82	0.92	0.87			
K1	_	_	0.305			
K2	_		0.225			
Z	_		0.20			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type E)



Dimensions	Value				
Dillielisions	(in mm)				
С	0.650				
Х	0.400				
X1	0.285				
X2	1.050				
Y	0.500				
Y1	0.920				
Y2	1.600				
Y3	2 300				



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